

AN11051

Pin FMEA for HEF4000 family

Rev. 2 — 15 July 2015

Application note

Document information

Info	Content
Keywords	FMEA, HEF4000, CMOS, wide operating supply range (3 V to 15 V)
Abstract	This application note provides a Failure Modes and Effects Analysis (FMEA) for the device pins of the NXP Semiconductors' HEF4000 family under typical failure situations



Revision history

Rev	Date	Description
v 1.0	20110428	initial version
v. 2.0	20150715	Table 4 : Added pin V _{EE}

Contact information

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1. Introduction

Though the HEF4000 series is one of the oldest CMOS logic families around, it is still frequently used in new designs because of its ease of design-in, wide operating supply range (3 V to 15 V), excellent noise immunity, and low power consumption. All of the standard functions are available, plus more specialized functions such as IEEE bus interfaces and PLL frequency synthesizers.

2. Pin FMEA

This application note provides a Failure Modes and Effects Analysis (FMEA) for the device pins of the NXP Semiconductor AUP family under typical failure situations such as a short-circuit to V_{DD} or V_{SS} or to a neighboring pin, or if a pin is left open.

Some HEF4000 family devices have special functions, that can have different behaviors. A failure is classified according to its effect on the HEF4000 device and the functionality of the application; see [Table 1](#).

Table 1. Classification of failure effects

Class	Failure effect
A	damage to device affects application functionality
B	no damage to device may affect application functionality
C	no damage to device no affect to application functionality

Table 2. FMEA matrix for pin short-circuit to V_{DD}

Pin	Class	Remarks
Input	B	normal operating condition, no damage, no leakage, may affect functionality
Output	C	if output defined HIGH, no damage, no leakage, no output level change
Output	A	if output defined LOW, short-circuits and high currents can damage device, output level changes
V_{SS}	B	short-circuits and high currents can damage device, will affect functionality

Table 3. FMEA matrix for pin short-circuit to V_{SS}

Pin	Class	Remarks
Input	B	normal operating condition, no damage, no leakage, may affect functionality
Output	C	if output defined LOW, no damage, no leakage, no output level change
Output	A	if output defined HIGH, short-circuits and high currents can damage device, output level changes
V_{DD}	B	no damage to device, will affect functionality

Table 4. FMEA matrix for pin left open

Pin	Class	Remarks
Input	B	undefined operating condition, no damage, increases leakage, may affect functionality
Output	C	normal operating condition, no damage, no leakage
V_{SS} ; V_{EE}	B	undefined operating condition, no damage, increases leakage, will affect functionality
V_{DD}	B	undefined operating condition, no damage, increases leakage (only for I/O types), will affect functionality

Table 5. FMEA matrix for pin short-circuits between neighboring pins

Pin	Class	Remarks
Input to input	C	if inputs have same voltage levels: no damage, no leakage
	B	if inputs have different voltage levels: leakage increases, will affect functionality
Input to output	A	if input and output have different voltage levels, can cause high current and can damage device, will affect functionality
	C	if input and output have same voltage levels, no damage, no leakage
Input to V_{SS}	-	see Table 3
Input to V_{DD}	-	see Table 2
Output to output	C	if outputs have same voltage levels, no damage, no leakage
	A	if outputs have different voltage levels, can cause high current and can damage device, will affect functionality
Output to input	-	same effect as 'input to output' condition
Output to V_{SS}	-	see Table 3
Output to V_{DD}	-	see Table 2
V_{SS} to V_{DD}	-	not applicable, these pins are not neighbors

3. Abbreviations

Table 6. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
FMEA	Failure Modes and Effects Analysis
PLL	Phase-Locked Loop

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Date of release: 15 July 2015

Document identifier: AN11051

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